

ACCURATE NONLINEAR RESISTIVE FET MODELING FOR IMD CALCULATIONS

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ABSTRACT

This work discusses the nonlinear modeling procedures required for intermodulation distortion (IMD) calculations of MESFETs biased in the resistive (linear) region. An automatic full two-sided characterization of $I_{ds}(V_{gs}, V_{ds})$ is compared against the previously published extraction of $I_{ds}(V_{ds})$ in this problematic region. It is shown that this one-sided Taylor series extraction is insufficient for most applications of the FET in its triode zone, and thus an alternative method is proposed.

INTRODUCTION

In a now classic paper [1] Maas proposed the GaAs MESFET as an appropriate device for RF and microwave mixing applications, when it is biased in the so-called "linear" or triode zone. The fundamental argument is the high linearity (e. g. low intermodulation distortion, IMD) that can be obtained if the FET's gate controlled resistor-like operation is used in resistive mixers or MESFET switches. However, soon it was recognized that the device's "linear" zone was not so linear as it was ideally expected, which motivated the publication of a method for an IMD model extraction [2],[3]. That model assumes that, in the triode zone, the bi-dimensional nature of drain source current, $I_{ds}(V_{gs}, V_{ds})$, can be approximately ignored and thus only the dependence of I_{ds} on the output voltage, V_{ds} , was characterized.

The main objective of this paper is to show that this oversimplified modeling procedure is insufficient for many applications, and to propose a complete set-up that enables the full Taylor series $I_{ds}(V_{gs}, V_{ds})$ coefficients independent extraction.

ACCURATE NONLINEAR CHARACTERIZATION

To study the impact of the various $I_{ds}(V_{gs}, V_{ds})$ Taylor series coefficients on the IMD performance of the MESFET voltage controlled channel resistance, we started by the general connection topology represented in Fig. 1. In cold FET mixers [1], [3], [4], the device is connected in a common source configuration with $I_1(\omega)=0$ ($I_2(\omega)$ plays the role of local oscillator). In FET bi-directional switches the channel resistance is either used in series (common gate configuration with $I_2(\omega)=I_3(\omega)=0$ or $I_2(\omega)=I_1(\omega)=0$), or in parallel (common source configuration with $I_2(\omega)=I_1(\omega)=0$) [2].

In the case that will be analyzed next, the MESFET is under characterization and mounted in a common source configuration, driven at the gate and drain terminals. Therefore, $I_1(\omega)=0$, and $Y_1(\omega)$ is simply composed by the device's source parasitics.

It is assumed that in the quiescent point (two fixed DC values for MESFET switches and a time varying bias point for MESFET mixers) $I_{ds}(V_{gs}, V_{ds})$ can be expanded in a Taylor series as:

$$I_{ds}(V_{gs}, V_{ds}) = I_{ds_{DC}} + G_m \cdot v_{gs} + G_{ds} \cdot v_{ds} + G_{m2} \cdot v_{gs}^2 + G_{md} \cdot v_{gs} \cdot v_{ds} + G_{d2} \cdot v_{ds}^2 + G_{m3} \cdot v_{gs}^3 + G_{m2d} \cdot v_{gs}^2 \cdot v_{ds} + G_{md2} \cdot v_{gs} \cdot v_{ds}^2 + G_{d3} \cdot v_{ds}^3 + \dots \quad (1)$$

In this way, and applying the Nonlinear Currents Method of Volterra series [5], to the multi-port circuit of Fig. 1, it can be shown that 1st order control voltages are:

$$V_{gs}^{(1)}(\omega) = Z_{42} \cdot I_2(\omega_1) + Z_{43} \cdot I_3(\omega_2) \quad (2)$$

$$V_{ds}^{(1)}(\omega) = Z_{52} \cdot I_2(\omega_1) + Z_{53} \cdot I_3(\omega_2) \quad (3)$$

(where Z_{ij} are various impedance parameters that were used to describe the network), and thus 2nd order drain current at $(2\omega_2)$ is given by:

$$I_{ds}^{(2)}(2\omega_2) = [Z_{43}^2 \cdot G_{m2} + Z_{43} \cdot Z_{53} \cdot G_{md} + Z_{53}^2 \cdot G_{d2}] \cdot I_3(\omega_2)^2 \quad (4)$$

while 3rd order drain current component at $(3\omega_2)$ is:

$$I_{ds}(3\omega_2) = [Z_{43}^3 \cdot G_{m3} + Z_{43}^2 \cdot Z_{53} \cdot G_{m2d} + Z_{43} \cdot Z_{53}^2 \cdot G_{md2} + Z_{53}^3 \cdot G_{d3}] \cdot I_3(\omega_2)^3 + [2 \cdot G_{m2} \cdot V_{gs}(2\omega_2) \cdot V_{gs}(\omega_2) + G_{md} \cdot V_{gs}(2\omega_2) \cdot V_{ds}(\omega_2) + G_{md} \cdot V_{gs}(\omega_2) \cdot V_{ds}(2\omega_2) + 2 \cdot G_{d2} \cdot V_{ds}(2\omega_2) \cdot V_{ds}(\omega_2)] \quad (5)$$

Since, for $V_{ds}=0$, $I_{ds}=0$ independent of V_{gs} , all drain current derivatives in respect to V_{gs} must also be zero: $G_m=G_{m2}=G_{m3}=0$. However, as long as cross dependence of I_{ds} on V_{gs} and V_{ds} is concerned, nothing similar can be said, and so G_{md} , G_{m2d} and G_{md2} should, in principle, be expected to present non null values. Therefore, the previously published model extraction procedure is implicitly neglecting $Z_{43} \cdot G_{md}$ in comparison to $Z_{53} \cdot G_{d2}$ in 2nd order I_{ds} (4) and neglecting $[Z_{43}^2 \cdot G_{m2d} + Z_{43} \cdot Z_{53} \cdot G_{md2}]$ in comparison to $Z_{53}^2 \cdot G_{d3}$ in 3rd order I_{ds} (5).

There are at least two reasons to discuss these approximations. First, since a cold FET mixer is recognized to be reasonably linear for RF [$V_{ds}(\omega_2)^n \approx 0$] but still presents a useful frequency conversion efficiency [$V_{gs}(\omega_1) \cdot V_{ds}(\omega_2) \neq 0$], it should not be expected that G_{d2} (output nonlinearity) dominates 2nd order distortion performance over G_{md} (input-output nonlinearity), nor G_{d3} over G_{m2d} and G_{md2} . In fact, since G_{md} can be defined as the derivative of G_{ds} in respect to V_{gs} , it is the coefficient of (1) that describes (in a weak nonlinearity sense) the channel resistance control imposed by V_{gs} , exactly the phenomenon used in a resistive FET mixer.

And second, at VHF, where such a model is usually extracted, the device is almost unilateral, except for the current-series feedback created by the parasitic MESFET source resistance, R_s . Thus, Z_{43} represents the gate voltage developed by channel current in R_s . On the other hand, Z_{53} represents the

voltage developed across the channel resistance, $R_{ds}=1/G_{ds}$, and so Z_{43}/Z_{53} should present a similar ratio to R_s/R_{ds} . At $V_{DS}=0$ R_{ds} is only a few ohms, and so it is not clear that $Z_{43} \ll Z_{53}$.

EXPERIMENTAL RESULTS

To prove these qualitative arguments, a $6 \times 50 \mu\text{m}$ MESFET from a GEC Marconi F20 process wafer was fully characterized in its triode and saturated regions using an automatic double sided set-up, based on the one proposed in [6]. Measured values of G_{ds} , G_{md} , G_{d2} , G_{m2d} , G_{md2} and G_{d3} for $-2.3\text{V} < V_{GS} < 0\text{V}$ and $V_{DS}=0$ are presented in Fig. 2 and Fig. 3.

For comparison purposes, Fig. 2 also shows G_{d2} and G_{d3} coefficients that would be obtained with the previous one-sided simplified approach.

The obvious differences between the G_{d2} and G_{d3} pairs seen in Fig. 2 are really a measure of the impact of all other coefficients. Since, in a practical application, embedding device admittances, and transimpedance gains between ports, are much different from the conditions used for model extraction (e. g. microwave frequencies against VHF used in the set-up, or unmatched input/output terminations) the use of only G_{d2} and G_{d3} to predict cold FET IMD behavior would be very inaccurate. This clearly justifies the need for the now proposed complete resistive FET two-sided characterization procedure.

CONCLUSIONS

The one-sided Taylor series characterization for the drain source nonlinear current has been proven to be inaccurate for IMD prediction on FET devices in cold operation. A complete two-sided description, able to include the important cross terms, has been suggested to properly evaluate the small-signal nonlinear behaviour of these devices in this problematic region; giving us the possibility of correctly describing important applications such as resistive mixers, switches, etc.

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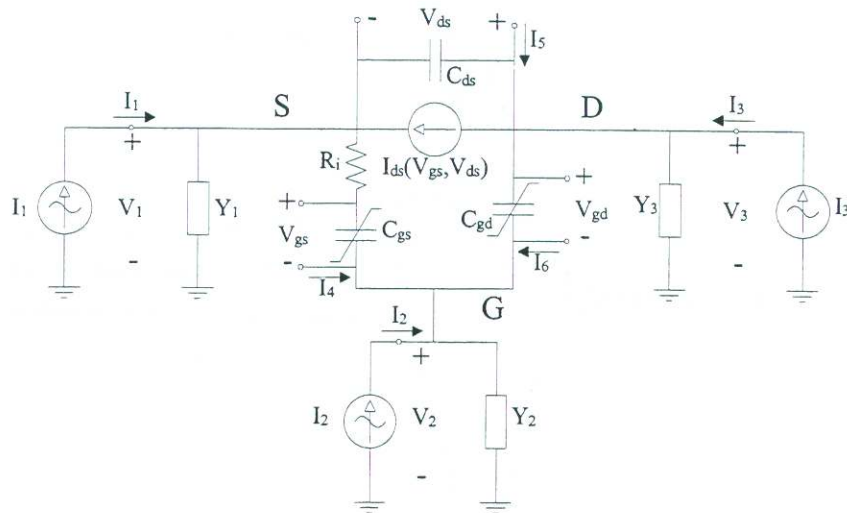


Fig. 1 - Equivalent circuit model of general FET topology.

F20 6*50 μm GEC Marconi

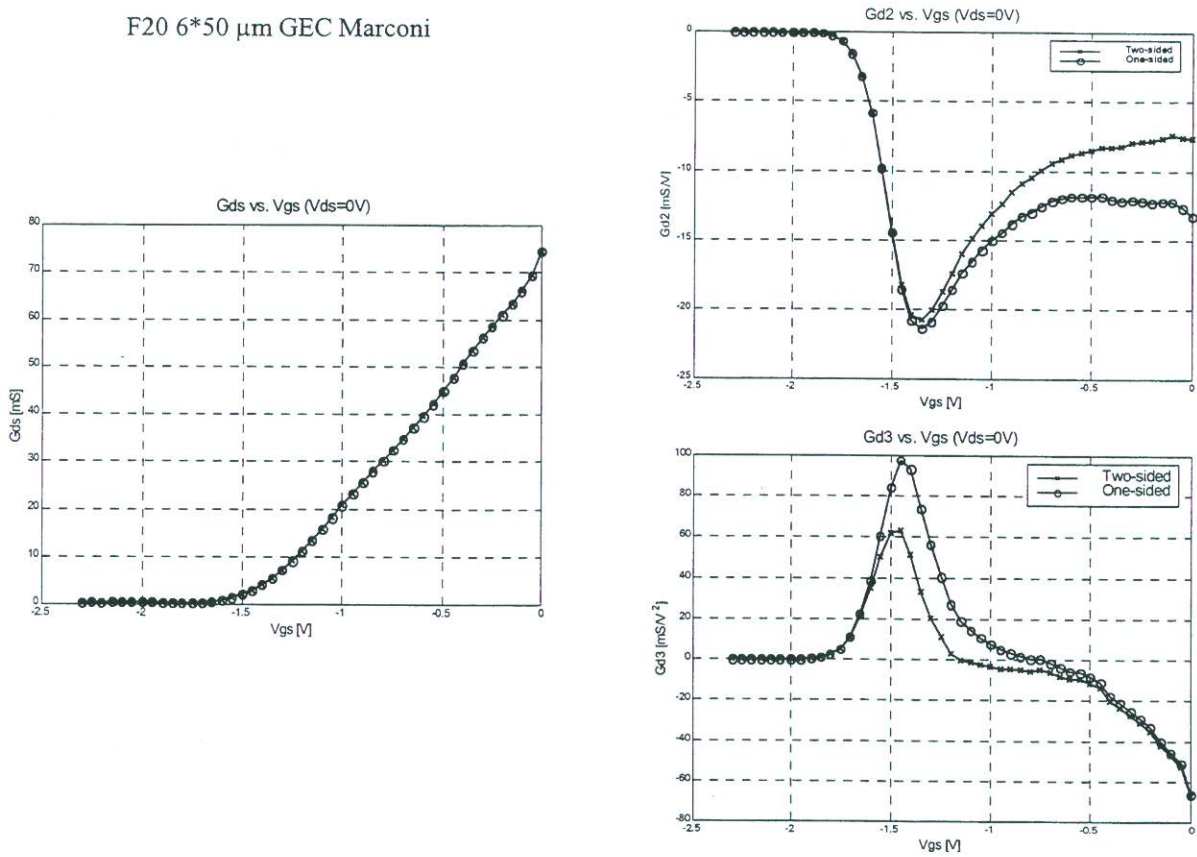


Fig. 2 - Extracted G_{ds} , G_{d2} and G_{d3} for the one-sided and two-sided characterizations
 @ $V_{DS}=0$ and $-2.3V < V_{GS} < 0V$.

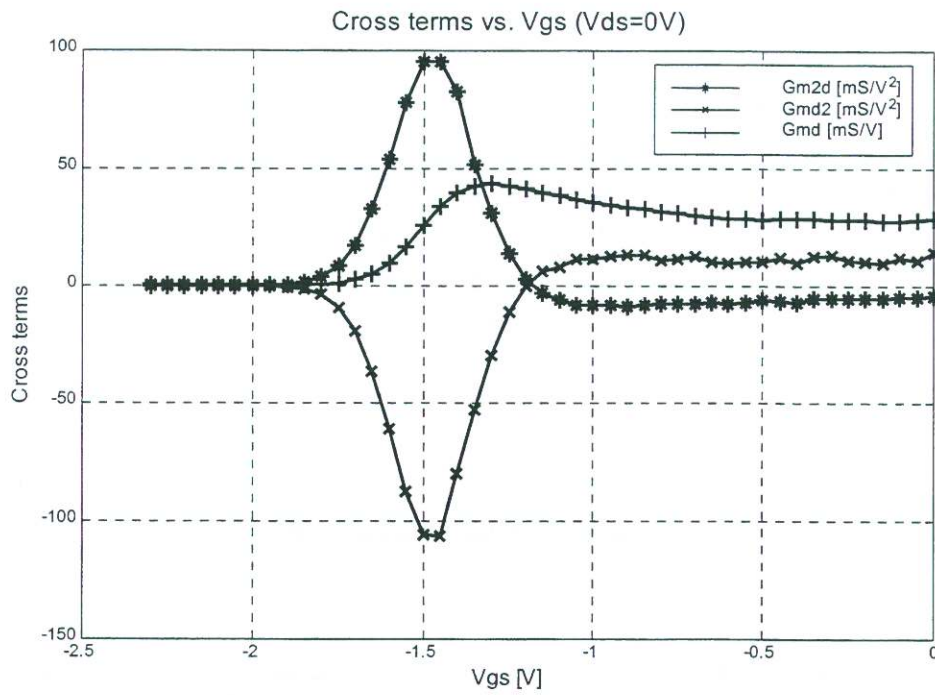


Fig. 3 - Extracted G_{md} , G_{m2d} and G_{md2} @ $V_{DS}=0$ and $-2.3V < V_{GS} < 0V$.